

Data brief

# Android / Linux sensor HAL for MEMS motion and environmental sensors (Industrial I/O framework)



### **Features**

- Android / Linux sensor hardware abstraction layer (HAL) for IIO framework
- · Available in the STMicroelectronics public GitHub repository

## **Description**

STMicroelectronics provides the ST Android / Linux sensor hardware abstraction layer (HAL) for the Linux IIO device system; it defines a standard interface for ST sensors, allowing Android / Linux to be agnostic about lower-level driver implementations.

Integration details are available in the README section of the GitHub repository.

Product summary		
Android / Linux sensor HAL for MEMS motion and environmental sensors (Industrial I/O framework)	AndroidLinuxHAL	



# **Revision history**

Table 1. Document revision history

Date	Revision	Changes
06-Dec-2022	1	Initial release

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